

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2638174

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>TSUNEHIKO HONNA</td> <td>11/28/2013</td> </tr> <tr> <td>MINORU ISHIKAWA</td> <td>11/28/2013</td> </tr> </tbody> </table>		Name	Execution Date	TSUNEHIKO HONNA	11/28/2013	MINORU ISHIKAWA	11/28/2013				
Name	Execution Date										
TSUNEHIKO HONNA	11/28/2013										
MINORU ISHIKAWA	11/28/2013										
RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>SEIDEN MFG. CO., LTD.</td> </tr> <tr> <td>Street Address:</td> <td>300-6, SHIMOECHI, ATSUGI-SHI</td> </tr> <tr> <td>City:</td> <td>KANAGAWA</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>243-0806</td> </tr> </table>		Name:	SEIDEN MFG. CO., LTD.	Street Address:	300-6, SHIMOECHI, ATSUGI-SHI	City:	KANAGAWA	State/Country:	JAPAN	Postal Code:	243-0806
Name:	SEIDEN MFG. CO., LTD.										
Street Address:	300-6, SHIMOECHI, ATSUGI-SHI										
City:	KANAGAWA										
State/Country:	JAPAN										
Postal Code:	243-0806										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14124046</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14124046						
Property Type	Number										
Application Number:	14124046										
CORRESPONDENCE DATA											
Fax Number:	(617)720-9601										
Phone:	617-720-9600										
Email:	dfreitas@bannerwitcoff.com, jiwanicki@bannerwitcoff.com, BWPTOPAT@bannerwitcoff.com										
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>											
Correspondent Name:	BANNER & WITCOFF, LTD.										
Address Line 1:	28 STATE STREET										
Address Line 2:	SUITE 1800										
Address Line 4:	BOSTON, MASSACHUSETTS 02109-1701										
ATTORNEY DOCKET NUMBER:	007801.00005										
NAME OF SUBMITTER:	JOHN P. IWANICKI, REG. NO. 34,628										
Signature:	/John P. Iwanicki/										

Date:

12/05/2013

Total Attachments: 2

source=Assignment#page1.tif

source=Assignment#page2.tif

ASSIGNMENT

In consideration of One Dollar (\$1.00) and other good and valuable considerations in hand paid, the receipt and sufficiency whereof are hereby acknowledged, the undersigned hereby assigns to:

SEIDEN MFG. CO., LTD.
of Kanagawa, JAPAN

its successors and assigns, the entire right, title and interest in the invention or improvements of the undersigned disclosed in U.S. Application Serial Number 14/124,046 filed December 5, 2013 (Attorney Docket No. 007801.00005) entitled:

HIGH FREQUENCY TRANSFORMER

and in said application and any and all other applications, both United States and foreign, which the undersigned may file, either solely or jointly with others, including all continuations, continuations-in-part, and divisions on said invention or improvements, and in any and all Letters Patent of the United States and foreign countries, which may be obtained on any of said applications, and in any reissue or extension of such patents, and further assign to said assignee the priority right provided by the International Convention.

The undersigned hereby authorizes and requests the Commissioner of Patents and Trademarks to issue said Letters Patent to said assignee.

The undersigned hereby authorizes and requests the attorneys of record in said application to insert in this assignment the filing date and serial number of said application when officially known, if not already present.

The undersigned warrants to be the owner of the entire right, title and interest in said invention or improvements herein assigned and to have the right to make this assignment, and further warrant that there are no outstanding prior assignments, licenses, or other encumbrances on the interest herein assigned.

For said considerations the undersigned hereby agrees, upon the request and at the expense of said assignee, its successors and assigns, to execute any and all divisional, continuation and substitute applications for said invention or improvements, and any necessary oath, affidavit or declaration relating thereto, and any application for the reissue or extension of any Letters Patent that may be granted upon said application and any and all applications and other documents for Letters Patent in foreign countries on said invention or improvements, that said assignee, its successors or assigns may deem necessary or expedient, and for the said considerations the undersigned authorize said assignee to apply for patents for said invention or improvements in its

Assignment of Rights to Invention

own name in such countries where such procedure is proper and further agree, upon the request of said assignee, its successors and assigns, to cooperate to the best of the ability of the undersigned with said assignee, its successors and assigns, in any proceedings or transactions involving such applications or patents, including the preparation and execution of preliminary statements, giving and producing evidence, and performing any and all other acts necessary to obtain, maintain and enforce said Letters Patent, both United States and foreign, and vest all rights therein hereby conveyed in the assignee, its successors and assigns, whereby said Letters Patent will be held and enjoyed by the said assignee, its successors and assigns, to the full end of the term for which said Letters Patent will be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment had not been made.

Date: NOV/28/2013
(month/day/year)

Tsunehiko HONNA
Tsunehiko HONNA

Date: NOV/28/2013
(month/day/year)

Minoru ISHIKAWA
Minoru ISHIKAWA

Assignment of Rights to Invention